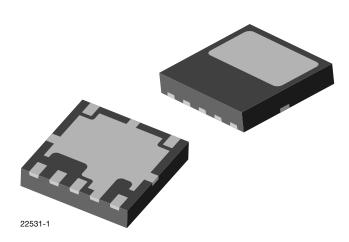


IR Receiver Modules for Remote Control Systems



DESIGN SUPPORT TOOLS AVAILABLE



ORDERING CODE

Taping:

TSSP57038TT1 - top view taped TSSP57038TT2 - top view taped

FEATURES

- Up to 2 m for presence sensing
- Uses modulated bursts at 38 kHz
- PIN diode and sensor IC in one package
- Low supply current
- Shielding against EMI
- · Visible light is suppressed by IR filter
- Insensitive to supply voltage ripple and noise
- Supply voltage: 2.5 V to 5.5 V
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

The TSSP57038 is a compact infrared detector module for presence sensing applications. It receives 38 kHz modulated signals and has a peak sensitivity of 940 nm.

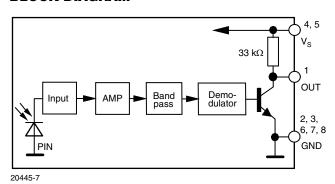
This component has not been qualified according to automotive specifications.

APPLICATIONS

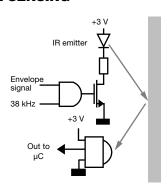
- Reflective sensors for hand dryers, towel or soap dispensers, water faucets, toilet flush
- · Vending machine fall detection
- Security and pet gates
- Person or object vicinity activation

PARTS TABLE				
Carrier frequency	Carrier frequency 38 kHz TSSP57038			
Package		Belobog		
Pinning		$1 = OUT, 2, 3, 6, 7, 8 = GND, 4, 5 = V_S$		
Dimensions (mm)		3.95 W x 3.95 H x 0.8 D		
Mounting		SMD		
Application		Presence sensors		

BLOCK DIAGRAM



PRESENCE SENSING







COMPLIANT HALOGEN

GREEN (5-2008)



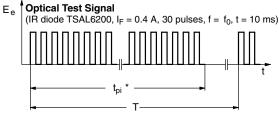
ABSOLUTE MAXIMUM R	LUTE MAXIMUM RATINGS				
PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT	
Supply voltage		Vs	-0.3 to +6	V	
Supply current		I _S	5	mA	
Output voltage		V _O	-0.3 to (V _S + 0.3)	V	
Output current		I _O	5	mA	
Junction temperature		T _j	100	°C	
Storage temperature range		T _{stg}	-25 to +85	°C	
Operating temperature range		T _{amb}	-25 to +85	°C	
Power consumption	T _{amb} ≤ 85 °C	P _{tot}	10	mW	

Note

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only
and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification
is not implied. Exposure to absolute maximum rating conditions for extended periods may affect the device reliability

ELECTRICAL AND OPTI	CAL CHARACTERISTICS	(T _{amb} = 25 °	°C, unless o	therwise s	pecified)	
PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Supply current (pin 3)	$E_{V} = 0, V_{S} = 5 V$	I _{SD}	0.55	0.7	0.9	mA
Зарріў сапені (рін э)	$E_v = 40 \text{ klx, sunlight}$	I _{SH}	-	0.8	-	mA
Supply voltage		Vs	2.5	-	5.5	V
Transmission distance	E_v = 0, test signal see Fig. 1, IR diode TSAL6200, I_F = 50 mA	d	-	8	-	m
Output voltage low (pin 1)	$I_{OSL} = 0.5 \text{ mA}, E_e = 2 \text{ mW/m}^2,$ test signal see Fig. 1	V _{OSL}	-	-	100	mV
Minimum irradiance	Pulse width tolerance: t_{pi} - 5/ f_o < t_{po} < t_{pi} + 6/ f_o , test signal see Fig. 1	E _{e min.}	-	0.7	1.2	mW/m²
Maximum irradiance	t_{pi} - 5/f _o < t_{po} < t_{pi} + 6/f _o , test signal see Fig. 1	E _{e max.}	50	-	-	W/m ²
Directivity	Angle of half transmission distance	Ψ1/2	-	± 75	-	deg

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)



* $t_{pi} \geq 10/f_0$ is recommended for optimal function

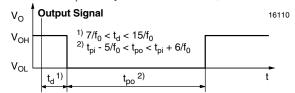


Fig. 1 - Output Active Low

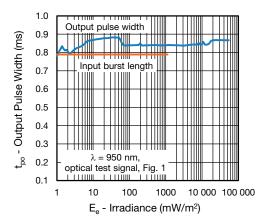


Fig. 2 - Pulse Length and Sensitivity in Dark Ambient

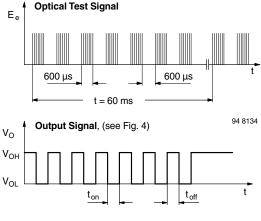


Fig. 3 - Output Function

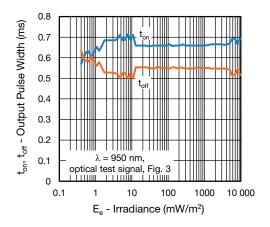


Fig. 4 - Output Pulse Diagram

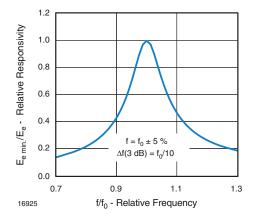


Fig. 5 - Frequency Dependence of Responsivity

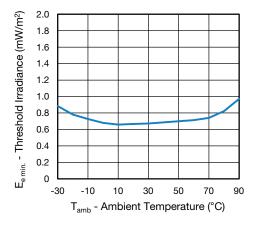


Fig. 6 - Sensitivity vs. Ambient Temperature

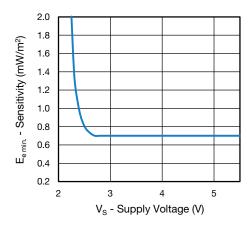


Fig. 7 - Sensitivity vs. Supply Voltage

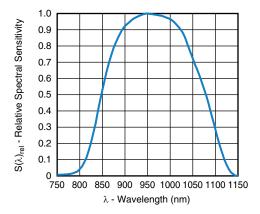


Fig. 8 - Relative Spectral Sensitivity vs. Wavelength

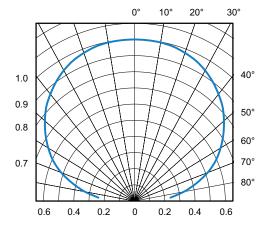
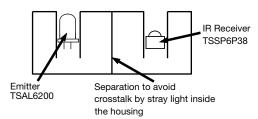


Fig. 9 - Horizontal Directivity

21947

The typical application of this device is a reflective or beam break sensor with active low "detect" or "no detect" information contained in its output. Applications requiring up to 2 m beam break or 1 m reflective range benefit from the lower gain of these sensors because they are less sensitive to stray signal from the emitter, simplifying the mechanical design.

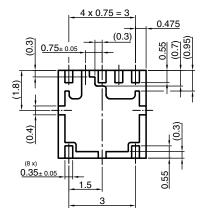
Example for a sensor hardware:

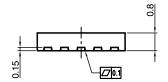


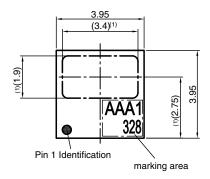
There should be no common window in front of the emitter and detector in order to avoid crosstalk via guided light through the window.



PACKAGE DIMENSIONS in millimeters



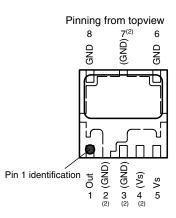




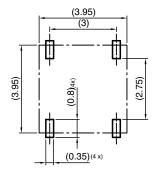
Drawing-No.: 6.550-5315.01-4 Issue: 2; 12.02.14



technical drawings according to DIN specifications



Proposed pad layout from component side (dim. for reference only)



Notes

(1) Optically effective area

(2) Pins connected internally. It is not necessary to connect externally



ASSEMBLY INSTRUCTIONS

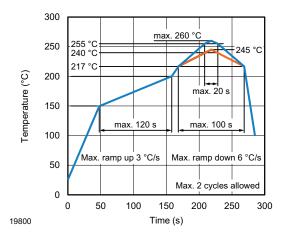
Reflow Soldering

- Reflow soldering must be done within 168 h while stored under a max. temperature of 30 °C, 60 % RH after opening the dry pack envelope
- Set the furnace temperatures for pre-heating and heating in accordance with the reflow temperature profile as shown in the diagram. Exercise extreme care to keep the maximum temperature below 260 °C. The temperature shown in the profile means the temperature at the device surface. Since there is a temperature difference between the component and the circuit board, it should be verified that the temperature of the device is accurately being measured
- Handling after reflow should be done only after the work surface has been cooled off

Manual Soldering

- Use a soldering iron of 25 W or less. Adjust the temperature of the soldering iron below 300 °C
- Finish soldering within 3 s
- Handle products only after the temperature has cooled off

VISHAY LEAD (Pb)-FREE REFLOW SOLDER PROFILE

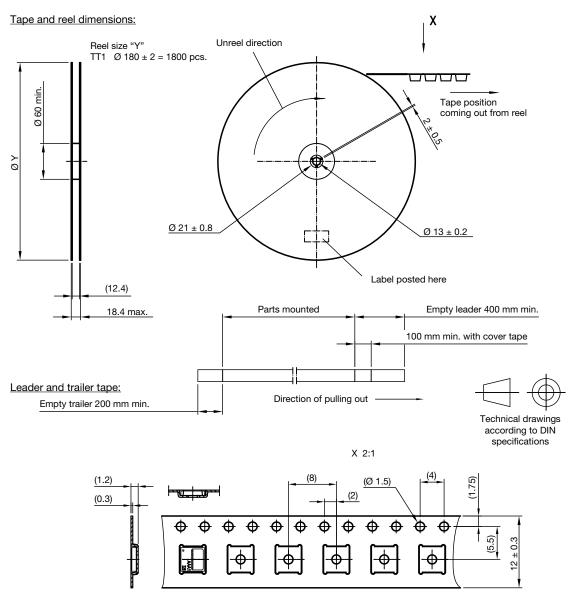


ORDERING INFORMATION			
ORDERING CODE	PACKAGING	VOLUME (1)	REMARKS
TSSP57038TT1	Tana and roal	MOQ: 1800 pcs	3.95 mm x 3.95 mm x 0.75 mm
TSSP57038TT2	Tape and reel	MOQ: 7000 pcs	3.93 11111 x 3.93 11111 x 0.73 11111

Note

(1) MOQ: minimum order quantity

TAPING VERSION TSSP57038 DIMENSIONS in millimeters



Drawing-No.: 9.700-5347.01-4

Issue: 2; 07.03.18

Not indicated tolerances ± 0.1

LABEL

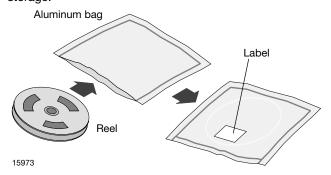
Standard bar code labels for finished goods

The standard bar code labels are product labels and used for identification of goods. The finished goods are packed in final packing area. The standard packing units are labeled with standard bar code labels before transported as finished goods to warehouses. The labels are on each packing unit and contain Vishay Semiconductor GmbH specific data.

VISHAT SEMICONDUCTOR	GmbH STANDARD BAR CODE PRO	DUCT LABEL (IIIIIsried goods)
PLAIN WRITING	ABBREVIATION	LENGTH
Item-description	-	18
Item-number	INO	8
Selection-code	SEL	3
LOT-/serial-number	BATCH	10
Data-code	COD	3 (YWW)
Plant-code	PTC	2
Quantity	QTY	8
Accepted by	ACC	-
Packed by	PCK	-
Mixed code indicator	MIXED CODE	-
Origin	xxxxxx+	Company logo
Long bar code top	Туре	Length
Item-number	N	8
Plant-code	N	2
Sequence-number	X	3
Quantity	N	8
Total length	-	21
Short bar code bottom	Туре	Length
Selection-code	X	3
Data-code	N	3
Batch-number	X	10
Filter	-	1
Total length	-	17

DRY PACKING

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



FINAL PACKING

The sealed reel is packed into a cardboard box.

RECOMMENDED METHOD OF STORAGE

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 168 h under these conditions moisture content will be too high for reflow soldering.

In case of moisture absorption, the devices will recover to the former condition by drying under the following condition: 192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 125 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC $^{\circledR}$ standard J-STD-020 level 3 label is included on all dry bags.



www.vishay.com

Vishay Semiconductors

Caution This bag contains MOISTURE-SENSITIVE DEVICES 1. Calculated shelf life in sealed bag: 12 months at <40°C and <90% relative humidity (RH) 2. Peak package body temperature: 260 1f blank, see adjacent bar code label 3. After bag is opened, devices that will be subjected to reflow solder or other high temperature process must be a) Mounted within: 168 168 16 hours of factory conditions 30°C/60% RH, or b) Stored per J-STD-033 4. Devices require bake, before mounting, if: a) Humidity Indicator Card reads > 10% for level 2a - 5a devices or >60% for level 2 devices when read at 23±5°C b) 3a or 3b are not met 5. If baking is required, refer to IPC/JEDEC J-STD-033 for bake procedure Bag Seal Date: If blank, see adjacent bar code label Note: Level and body temperature defined by IPC/JEDEC J-STD-020

EIA JEDEC standard J-STD-020 level 3 label is included on all dry bags

ESD PRECAUTION

22650

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electrostatic sensitive devices warning labels are on the packaging.

VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.

BAR CODE PRODUCT LABEL (example)



2217



Legal Disclaimer Notice

Vishay

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